Supertex inc.

# 16-Channel Serial to Parallel Converter with High Voltage Backplane Driver and Push-Pull Outputs

#### **Features**

- ► HVCMOS<sup>®</sup> technology
- Output voltage up to +200V
- Shift register speed 500kHz @ V<sub>DD</sub> = 1.7V
- 16 high voltage outputs
- High voltage backplane driver
- CMOS input levels

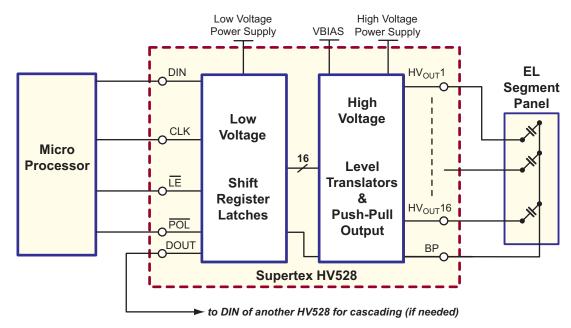
#### **Applications**

- Multiple segment EL display
- Piezoelectric transducer driver
- Braille driver

#### **General Description**

The HV528 is a 200V, 16-channel serial to parallel converter. The high voltage outputs and the backplane driver are designed to source and sink  $\pm 1.0$ mA.

The high voltage outputs are controlled by a 16-bit serial shift register, followed by a 16-bit latch. Data is shifted through the shift registers during the low to high clock transition. A data output buffer is provided for cascading multiple devices. Data is transferred to the 16-bit latch when a logic level low is applied to the LE input. Data is stored in the latch when LE is high. Output states are controlled by the data in the latch and by the POL pin.



#### **Typical Application Circuit**

#### **Ordering Information**

	Package Option						
Device	<b>32-Lead QFN</b> 5x5mm body, 1.0mm height (max), 0.50mm pitch						
HV528	HV528K6-G						
-G indicates package is RoHS compliant ('Green')							

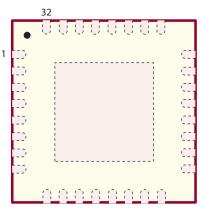


# **Absolute Maximum Ratings**

Parameter	Value
Logic supply, $V_{_{DD}}$	-0.5V to 7.0V
High voltage supply, $V_{_{PP}}$	215V
Translator supply voltage, $\rm V_{\rm {\tiny BIAS}}$	-0.5V to 7.0V
Logic input levels	-0.5V to V <sub>DD</sub> +0.5V
Operating junction temperature	-40°C to +125°C
Storage temperature range	-65°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

#### **Pin Configuration**



32-Lead QFN (K6) (top view) (Bottom side exposed center pad is at V<sub>pp</sub> potential)

#### **Product Marking**

HV528
LLLLLL YYWW
AAACCC

L = Lot Number YY = Year Sealed WW = Week Sealed A = Assembler ID C = Country of Origin

\_\_ = "Green" Packaging

32-Lead QFN (K6)

# **Operating Supply Voltages and Conditions**

Sym	Parameter	Min	Тур	Max	Units	Conditions
V <sub>DD</sub>	Logic supply voltage	1.7	3.0	5.5	V	
V <sub>BIAS</sub>	Level translator supply voltage	5.4	-	6.6	V	
V <sub>PP</sub>	Positive high voltage supply	50	-	200	V	
V <sub>IH</sub>	High-level input voltage	0.9V <sub>DD</sub>	-	V <sub>DD</sub>	V	
V <sub>IL</sub>	Low-level input voltage	0	-		V	
T <sub>A</sub>	Operating temperature	0	-	+70	°C	

Notes:

1. External ground noise reduction circuit will be provided by design upon characterization.

#### Power-up sequence should be the following\*:

- 1. Apply ground
- 2. Apply V<sub>DD</sub>
- 3. Set all inputs (D<sub>IN</sub>, CLK, LE , POL) to a known state
- 4. Apply  $V_{BIAS}$
- 5. Apply V<sub>PP</sub>

#### Power-down sequence should be the reverse of the above

\*This power up sequence requires an external high voltage diode between  $V_{DD}$  and  $V_{PP}$ . Without the diode, power up  $V_{PP}$  to a  $V_{DD}$  level first to bias the silicon substrate. After all other signals are powered, finish raising the  $V_{PP}$  to its final level.

Sym	Parameter	Min	Тур	Max	Units	Conditions	
I <sub>DD</sub>	V <sub>DD</sub> supply current	-	-	1.0	mA	f <sub>clk</sub> = 500kHz	
I <sub>DDQ</sub>	Quiescent V <sub>DD</sub> sup	ply current	-	-	10	μA	All logic inputs = $V_{DD}$ or 0V
I <sub>BIAS</sub>	V <sub>BIAS</sub> supply curren	-	-	100	μA	All HV <sub>OUTS</sub> switching at 1.0kHz. Peak $I_{BIAS}$ = 200mA with all channels switching	
I <sub>BIASQ</sub>	Quiescent V <sub>BIAS</sub> cu	-	-	10	μA	No $HV_{OUT}$ switching	
I <sub>PPQ</sub>	Quiescent V <sub>PP</sub> sup	-	-	100	μA	$V_{_{PP}}$ = 200V, outputs are static	
I <sub>IH</sub>	High-level logic inp	-	-	10	μA	$V_{IH} = V_{DD}$	
I <sub>IL</sub>	Low-level logic inp	ut current	-	-	-10	μA	$V_{IL} = 0V$
			V <sub>PP</sub> -30V	-	-	V	$IHV_{OUT} = -1.0mA$ , $50V \le V_{PP} \le 100V$
V <sub>OH</sub>	High level output	HV <sub>OUT</sub> & BP	V <sub>PP</sub> -16V	-	-	V	IHV <sub>OUT</sub> = -1.0mA, 100V < V <sub>PP</sub> ≤ 200V
		D <sub>out</sub>	V <sub>DD</sub> -1.0V	-	-	V	ID <sub>out</sub> = -1.0mA
N		HV <sub>out</sub> & BP	-	-	6.0	V	IHV <sub>OUT</sub> = 1.0mA
V <sub>OL</sub>	V <sub>oL</sub> Low level output	D <sub>OUT</sub>	-	-	1.0	V	ID <sub>out</sub> = 1.0mA
C <sub>DIN</sub>	Logic input capacit		-	-	10	pF	
C <sub>DOUT</sub>	Logic output capac	citance	-	-	10	pF	

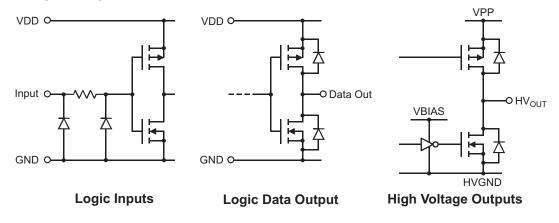
# DC Electrical Characteristics (Over operating supply voltages and temperature, unless otherwise noted)

#### AC Electrical Characteristics (Over operating supply voltages and temperature, unless otherwise noted)

Sym	Parameter	Min	Тур	Max	Units	Conditions
f <sub>clk</sub>	Clock frequency	0	-	500	kHz	
t <sub>c</sub>	Clock high / low pulse width	1.0	-	-	μs	
t <sub>su</sub>	Data setup time before clock rises	50	-	-	ns	
t <sub>H</sub>	Data hold time after clock rises	50	-	-	ns	
t <sub>CLE</sub>	LE from CLK setup time	15	-	-	ns	
t <sub>wLE</sub>	LE pulse width	100	-	-	ns	
t <sub>DD</sub>	Clock negative edge to $D_{_{OUT}}$ delay	-	-	150	ns	$C_{LDOUT} = 50 pF,$ ( $C_{LDOUT}$ includes $C_{DIN}$ and $C_{DOUT}$ )
t <sub>PHV</sub>	Delay time from inputs for HV <sub>out</sub> / BP to start rise/fall	-	-	500	ns	V <sub>PP</sub> = 200V, V <sub>BIAS</sub> = 5.4V
t <sub>or</sub>	HV <sub>OUTPUT</sub> / BP rise time	-	-	300	μs	C <sub>L</sub> = 1500pF, V <sub>PP</sub> = 200V
t <sub>oF</sub>	HV <sub>output</sub> / BP fall time	-	-	300	μs	$C_{L}$ = 1500pF, $V_{BIAS}$ = 5.4V, $V_{PP}$ = 200V
t <sub>oc</sub>	Width of POL pulses	$t_{_{PHV}}$ + $t_{_{OR}}/t_{_{OF}}$	-	-	μs	

## HV528

#### Input and Output Equivalent Circuits



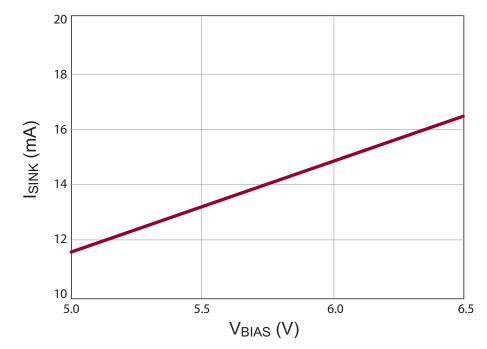
# **V**<sub>BIAS</sub> SUPPLY

The V<sub>BIAS</sub> supply operates from 5.4 to 6.6V. It is the gate drive voltage for all of the output N-channel MOSFETs. This allows the output peak current sink to be set by varying the V<sub>BIAS</sub> voltage. A higher V<sub>BIAS</sub> voltage will increase the current sinking capability.

The operating V\_{\_{\rm DD}} range is 1.7 to 5.5V. A plot showing the typical characteristics of I\_{\_{\rm SINK}} vs V\_{\_{\rm BIAS}} is shown below.

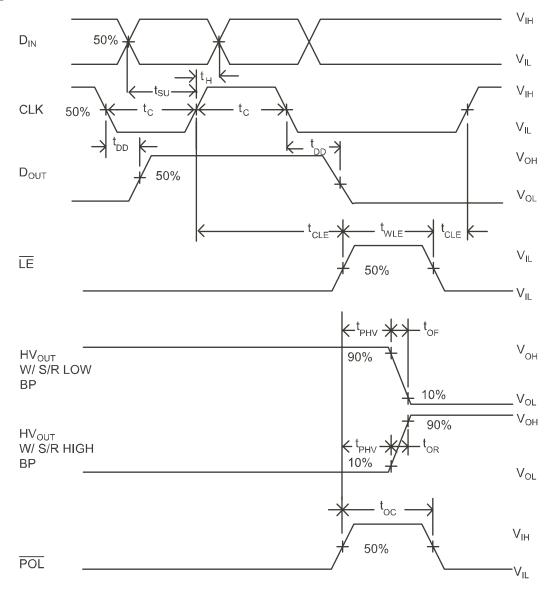
# Typical HV<sub>OUT</sub> $I_{SINK}$ vs $V_{BIAS}$

 $(V_{PP} = 200V, C_{LOAD} = 1.0nF)$ 



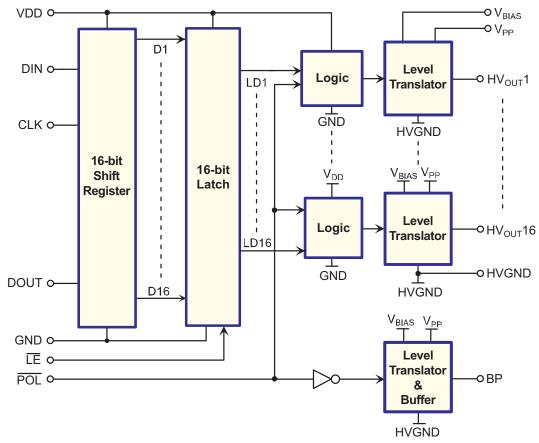
#### HV528

### **Switching Waveforms**



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#### **Functional Block Diagram**



#### **Function Table**

		Inp	uts		Outputs						
Function	DIN	CLK	Œ	POL	Shift Reg 1 216			DOUT			
Load S/R	H OR L	↑	Н	Х	HorL ●●	• ••	Х	•			
Transfer data in	Х	L	L	Н	* **	* **	L	•			
latch	Х	L	L	L	* **	* ** (b)	Н	•			
	Х	Х	Н	Н	• ••	• ••	L	•			
Store data in latches	Х	Х	Н	L	• ••	• •• (b)	Н	•			
Transporent mode	L	1	L	Н	L ●●	L ●●	L	•			
Transparent mode	Н	1	L	Н	Η ●●	Η ●●	L	•			
Invert mode	Х	Х	Н	L	• ••	• •• (b)	Н	x			
	Х	Х	Н	Н	• ••	• ••	L	Х			

#### Notes:

H = high level, L = low level, X = irrelevant,  $\uparrow$  = low-to-high transition\_

• = dependent on previous stage's state before the last CLK or last LE low

\* = data at the last CLK  $\uparrow$ 

(b) = bar over all symbols

# HV528

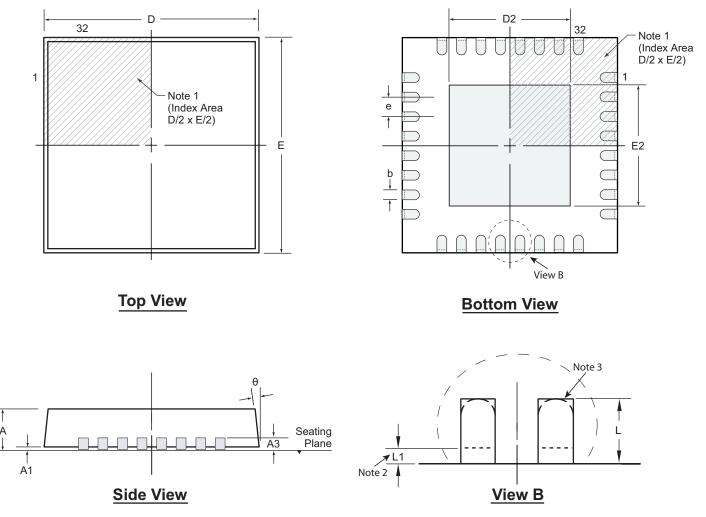
# **Pin Description**

Pin #	Function	Description
1	HV <sub>out</sub> 12	High voltage push-pull output
2	HV <sub>out</sub> 11	High voltage push-pull output
3	HV <sub>out</sub> 10	High voltage push-pull output
4	HV <sub>out</sub> 9	High voltage push-pull output
5	HV <sub>out</sub> 8	High voltage push-pull output
6	HV <sub>out</sub> 7	High voltage push-pull output
7	HV <sub>out</sub> 6	High voltage push-pull output
8	HV <sub>out</sub> 5	High voltage push-pull output
9	HV <sub>out</sub> 4	High voltage push-pull output
10	HV <sub>out</sub> 3	High voltage push-pull output
11	HV <sub>out</sub> 2	High voltage push-pull output
12	HV <sub>out</sub> 1	High voltage push-pull output
13	NC	No connect
14	VPP	High voltage supply
15	GND	Logic ground
16	NC	No connect
17	DIN	Data in
18	NC	No connect
19	CLK	Clock input logic
20	VDD	Logic supply voltage
21	POL	Polarity bar input logic
22	LE	Latch enable bar input logic
23	NC	No connect
24	DOUT	Data out
25	NC	No connect
26	VBIAS	Level translator bias voltage
27	HVGND	High voltage ground
28	BP	High voltage backplane output
29	HV <sub>out</sub> 16	High voltage push-pull output
30	HV <sub>out</sub> 15	High voltage push-pull output
31	HV <sub>out</sub> 14	High voltage push-pull output
32	HV <sub>out</sub> 13	High voltage push-pull output
Cei	nter Pad	The center pad is at VPP potential. Leave floating or connect to VPP. Do not ground.

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# 32-Lead QFN Package Outline (K6)

5x5mm body, 1.0mm height (max), 0.50mm pitch



Notes:

1. Details of Pin 1 identifier are optional, but must be located within the indicated area. The Pin 1 identifier may be either a mold, or an embedded metal or marked feature.

2. Depending on the method of manufacturing, a maximum of 0.15mm pullback (L1) may be present.

3. The inner tip of the lead may be either rounded or square.

Symb	ol	Α	A1	A3	b	D	D2	E	E2	е	L	L1	θ
1	MIN	0.80	0.00		0.18	4.85	1.05	4.85	1.05		0.45	0.00	0 <sup>0</sup>
Dimension (mm)	NOM	0.90	0.02	0.20 REF	0.25	5.00	-	5.00	-	0.50 BSC	0.50	-	-
(11111)	MAX	1.00	0.05		0.30	5.15	3.45	5.15	3.45	200	0.55	0.15	14 <sup>0</sup>

JEDEC Registration MO-220, Variation VHHD-6, Issue K, June 2006. Drawings not to scale.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.</u> supertex.com/packaging.html.)

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